Features

- Incorporates the ARM7TDMI® ARM® Thumb® Processor
 - High-performance 32-bit RISC Architecture
 - High-density 16-bit Instruction Set
 - Leader in MIPS/Watt
 - Embedded ICE In-circuit Emulation, Debug Communication Channel Support
- 64 Kbytes of Internal High-speed Flash, Organized in 512 Pages of 128 Bytes
 - Single Cycle Access at Up to 30 MHz in Worst Case Conditions,
 Prefetch Buffer Optimizing Thumb Instruction Execution at Maximum Speed
 - Page Programming Time: 4 ms, Including Page Auto-erase, Full Erase Time: 10 ms
 - 10,000 Write Cycles, 10-year Data Retention Capability, Sector Lock Capabilities,
 Flash Security Bit
 - Fast Flash Programming Interface for High Volume Production
- 16 Kbytes of Internal High-speed SRAM, Single-cycle Access at Maximum Speed
- Memory Controller (MC)
 - Embedded Flash Controller, Abort Status and Misalignment Detection
- Reset Controller (RSTC)
 - Based on Power-on Reset and Low-power Factory-calibrated Brownout Detector
 - Provides External Reset Signal Shaping and Reset Source Status
- Clock Generator (CKGR)
 - Low-power RC Oscillator, 3 to 20 MHz On-chip Oscillator and one PLL
- Power Management Controller (PMC)
 - Software Power Optimization Capabilities, Including Slow Clock Mode (Down to 500 Hz) and Idle Mode
 - Three Programmable External Clock Signals
- Advanced Interrupt Controller (AIC)
 - Individually Maskable, Eight-level Priority, Vectored Interrupt Sources
 - Two External Interrupt Sources and One Fast Interrupt Source, Spurious Interrupt Protected
- Debug Unit (DBGU)
 - 2-wire UART and Support for Debug Communication Channel interrupt,
 Programmable ICE Access Prevention
- Periodic Interval Timer (PIT)
 - 20-bit Programmable Counter plus 12-bit Interval Counter
- Windowed Watchdog (WDT)
 - 12-bit key-protected Programmable Counter
 - Provides Reset or Interrupt Signals to the System
 - Counter May Be Stopped While the Processor is in Debug State or in Idle Mode
- Real-time Timer (RTT)
 - 32-bit Free-running Counter with Alarm
 - Runs Off the Internal RC Oscillator
- One Parallel Input/Output Controller (PIOA)
 - Thirty-two Programmable I/O Lines Multiplexed with up to Two Peripheral I/Os
 - Input Change Interrupt Capability on Each I/O Line
 - Individually Programmable Open-drain, Pull-up resistor and Synchronous Output
- Eleven Peripheral DMA Controller (PDC) Channels
- One USB 2.0 Full Speed (12 Mbits per second) Device Port
 - On-chip Transceiver, 328-byte Configurable Integrated FIFOs



AT91 ARM[®] Thumb[®]-based Microcontrollers

AT91SAM7S64

Summary Preliminary

6070BS-ATARM-25-Feb-05





- One Synchronous Serial Controller (SSC)
 - Independent Clock and Frame Sync Signals for Each Receiver and Transmitter
 - I2S Analog Interface Support, Time Division Multiplex Support
 - High-speed Continuous Data Stream Capabilities with 32-bit Data Transfer
- Two Universal Synchronous/Asynchronous Receiver Transmitters (USART)
 - Individual Baud Rate Generator, IrDA Infrared Modulation/Demodulation
 - Support for ISO7816 T0/T1 Smart Card, Hardware Handshaking, RS485 Support
 - Full Modem Line Support on USART1
- One Master/Slave Serial Peripheral Interface (SPI)
 - 8- to 16-bit Programmable Data Length, Four External Peripheral Chip Selects
- One Three-channel 16-bit Timer/Counter (TC)
 - Three External Clock Inputs, Two Multi-purpose I/O Pins per Channel
 - Double PWM Generation, Capture/Waveform Mode, Up/Down Capability
- One Four-channel 16-bit PWM Controller (PWMC)
- One Two-wire Interface (TWI)
 - Master Mode Support Only, All Two-wire Atmel EEPROMs Supported
- One 8-channel 10-bit Analog-to-Digital Converter, Four Channels Multiplexed with Digital I/Os
- IEEE 1149.1 JTAG Boundary Scan on All Digital Pins
- 5V-tolerant I/Os, including Four High-current Drive I/O lines, Up to 16 mA Each
- Power Supplies
 - Embedded 1.8V Regulator, Drawing up to 100 mA for the Core and External Components
 - 3.3V VDDIO I/O Lines Power Supply, Independent 3.3V VDDFLASH Flash Power Supply
 - 1.8V VDDCORE Core Power Supply with Brownout Detector
- Fully Static Operation: Up to 55 MHz at 1.65V and 85° C Worst Case Conditions
- Available in a 64-lead LQFP Package

1. Description

Atmel's AT91SAM7S64 is a member of a series of low pincount Flash microcontrollers based on the 32-bit ARM RISC processor. It features a 64 Kbyte high-speed Flash and a 16 Kbyte SRAM, a large set of peripherals, including a USB 2.0 device, and a complete set of system functions minimizing the number of external components. The device is an ideal migration path for 8-bit microcontroller users looking for additional performance and extended memory.

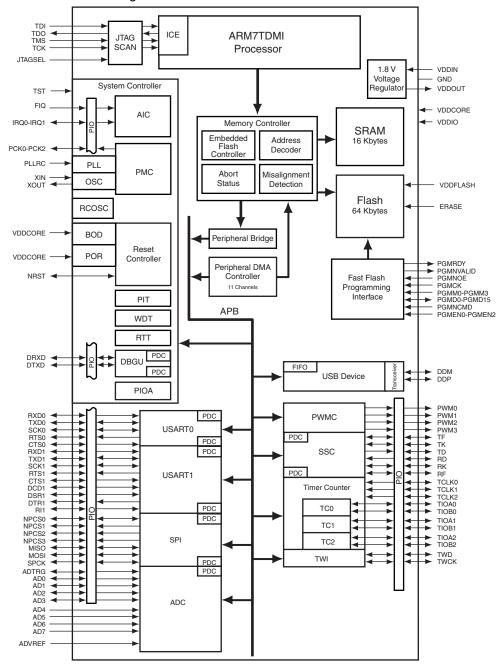
The embedded Flash memory can be programmed in-system via the JTAG-ICE interface or via a parallel interface on a production programmer prior to mounting. Built-in lock bits and a security bit protect the firmware from accidental overwrite and preserves its confidentiality.

The AT91SAM7S64 system controller includes a reset controller capable of managing the power-on sequence of the microcontroller and the complete system. Correct device operation can be monitored by a built-in brownout detector and a watchdog running off an integrated RC oscillator.

The AT91SAM7S64 is a general-purpose microcontroller. Its integrated USB Device port makes it an ideal device for peripheral applications requiring connectivity to a PC or cellular phone. Its aggressive price point and high level of integration pushes its scope of use far into the cost-sensitive, high-volume consumer market.

2. Block Diagram

Figure 2-1. AT91SAM7S64 Block Diagram







3. Signal Description

 Table 3-1.
 Signal Description List

Signal Name	Function	Туре	Active Level	Comments
	Powe	er		
VDDIN	Voltage Regulator Power Supply Input Power 3.0V to 3.6V			3.0V to 3.6V
VDDOUT	Voltage Regulator Output	Power		1.85V nominal
VDDFLASH	Flash Power Supply	Power		3.0V to 3.6V
VDDIO	I/O Lines Power Supply	Power		3.0V to 3.6V
VDDCORE	Core Power Supply	Power		1.65V to 1.95V
VDDPLL	PLL	Power		1.65V to 1.95V
GND	Ground	Ground		
	Clocks, Oscillato	ors and PLLs		
XIN	Main Oscillator Input	Input		
XOUT	Main Oscillator Output	Output		
PLLRC	PLL Filter	Input		
PCK0 - PCK2	Programmable Clock Output	Output		
	ICE and a	JTAG		
TCK	Test Clock	Input		No pull-up resistor
TDI	Test Data In	Input		No pull-up resistor
TDO	Test Data Out	Output		
TMS	MS Test Mode Select Input No pu		No pull-up resistor	
JTAGSEL	JTAG Selection	etion Input		Pull-down resistor
	Flash Me	mory		
ERASE Flash and NVM Configuration Bits Erase Command		Input	High	Pull-down resistor
	Reset/T	est		
NRST	Microcontroller Reset	I/O	Low	Pull-Up resistor
TST	Test Mode Select			Pull-down resistor
	Debug ⁽	Jnit		
DRXD	Debug Receive Data	Input		
DTXD	Debug Transmit Data			
	AIC	·		
IRQ0 - IRQ1	External Interrupt Inputs	Input		
FIQ Fast Interrupt Input		Input		

 Table 3-1.
 Signal Description List (Continued)

Signal Name	Function	Туре	Active Level	Comments
	F	PIO		
PA0 - PA31	Parallel IO Controller A	I/O		Pulled-up input at reset
	USB De	vice Port		
DDM	USB Device Port Data -	Analog		
DDP	USB Device Port Data +	Analog		
	US	ART		
SCK0 - SCK1	Serial Clock	I/O		
TXD0 - TXD1	Transmit Data	I/O		
RXD0 - RXD1	Receive Data	Input		
RTS0 - RTS1	Request To Send	Output		
CTS0 - CTS1	Clear To Send	Input		
DCD1	Data Carrier Detect	Input		
DTR1	Data Terminal Ready	Output		
DSR1	Data Set Ready	Input	Input	
RI1	Ring Indicator	Input		
	Synchronous	Serial Controller		
TD	Transmit Data	Output		
RD	Receive Data	Input		
TK Transmit Clock I/O				
RK	Receive Clock	I/O		
TF	Transmit Frame Sync	I/O		
RF	F Receive Frame Sync I/O			
	Timer/	Counter		
TCLK0 - TCLK2	External Clock Inputs	Input		
TIOA0 - TIOA2	I/O Line A	I/O		
TIOB0 - TIOB2	I/O Line B	I/O		
	PWM C	ontroller		
PWM0 - PWM3	PWM Channels	Output		
	•	SPI		
MISO	Master In Slave Out	I/O		
MOSI	Master Out Slave In	I/O		
SPCK	SPI Serial Clock	I/O		
NPCS0	SPI Peripheral Chip Select 0	I/O	Low	
NPCS1-NPCS3	SPI Peripheral Chip Select 1 to 3	Output	Low	





 Table 3-1.
 Signal Description List (Continued)

Signal Name	Function	Туре	Active Level	Comments
	Two-Wire Into	erface	1	
TWD	Two-wire Serial Data	I/O		
TWCK	Two-wire Serial Clock	I/O		
	Analog-to-Digital	Converter		
AD0-AD3	Analog Inputs	Analog		Digital pulled-up inputs at reset
AD4-AD7	Analog Inputs	Analog		Analog Inputs
ADTRG	ADC Trigger	Input		
ADVREF	ADC Reference	Analog		
	Fast Flash Programm	ning Interfac	е	
PGMEN0-PGMEN2	Programming Enabling	Input		
PGMM0-PGMM3	Programming Mode	Input		
PGMD0-PGMD15	Programming Data	I/O		
PGMRDY	Programming Ready	Output	High	
PGMNVALID	Data Direction	Output	Low	
PGMNOE	Programming Read	Input	Low	
PGMCK	Programming Clock	Input		
PGMNCMD	Programming Command	Input	Low	

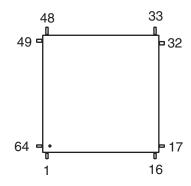
4. Package and Pinout

The AT91SAM7S64 is available in a 64-lead LQFP package.

4.1 64-lead LQFP Mechanical Overview

Figure 4-1 shows the orientation of the 64-lead LQFP package. A detailed mechanical description is given in the section Mechanical Characteristics of the full datasheet.

Figure 4-1. 64-lead LQFP Package Pinout (Top View)



4.2 Pinout

Table 4-1.AT91SAM7S64 Pinout in 64-lead LQF Package

1	ADVREF
2	GND
3	AD4
4	AD5
5	AD6
6	AD7
7	VDDIN
8	VDDOUT
9	PA17/PGMD5/AD0
10	PA18/PGMD6/AD1
11	PA21/PGMD9
12	VDDCORE
13	PA19/PGMD7/AD2
14	PA22/PGMD10
15	PA23/PGMD11
16	PA20/PGMD8/AD3

17	GND
18	VDDIO
19	PA16/PGMD4
20	PA15/PGMD3
21	PA14/PGMD2
22	PA13/PGMD1
23	PA24/PGMD12
24	VDDCORE
25	PA25/PGMD13
26	PA26/PGMD14
27	PA12/PGMD0
28	PA11/PGMM3
29	PA10/PGMM2
30	PA9/PGMM1
31	PA8/PGMM0
32	PA7/PGMNVALID

33	TDI		
34	PA6/PGMNOE		
35	PA5/PGMRDY		
36	PA4/PGMNCMD		
37	PA27/PGMD15		
38	PA28		
39	NRST		
40	TST		
41	PA29		
42	PA30		
43	PA3		
44	PA2		
45	VDDIO		
46	GND		
47	PA1/PGMEN1		
48	PA0/PGMEN0		

49	TDO
50	JTAGSEL
51	TMS
52	PA31
53	TCK
54	VDDCORE
55	ERASE
56	DDM
57	DDP
58	VDDIO
59	VDDFLASH
60	GND
61	XOUT
62	XIN/PGMCK
63	PLLRC
64	VDDPLL
64	VDDPLL



5. Power Considerations

5.1 Power Supplies

The AT91SAM7S64 has six types of power supply pins and integrates a voltage regulator, allowing the device to be supplied with only one voltage. The six power supply pin types are:

- VDDIN pin. It powers the voltage regulator; voltage ranges from 3.0V to 3.6V, 3.3V nominal. If the voltage regulator is not used, VDDIN should be connected to GND.
- VDDOUT pin. It is the output of the 1.8V voltage regulator.
- VDDIO pin. It powers the I/O lines and the USB transceivers; dual voltage range is supported. Ranges from 3.0V to 3.6V, 3.3V nominal.
- VDDFLASH pin. It powers a part of the Flash and is required for the Flash to operate correctly; voltage ranges from 3.0V to 3.6V, 3.3V nominal.
- VDDCORE pins. They power the logic of the device; voltage ranges from 1.65V to 1.95V, 1.8V typical. It can be connected to the VDDOUT pin with decoupling capacitor.
 VDDCORE is required for the device, including its embedded Flash, to operate correctly.
- VDDPLL pin. It powers the oscillator and the PLL. It can be connected directly to the VDDOUT pin.

No separate ground pins are provided for the different power supplies. Only GND pins are provided and should be connected as shortly as possible to the system ground plane.

5.2 Power Consumption

The AT91SAM7S64 has a static current of less than 60 μA on VDDCORE at 25°C, including the RC oscillator, the voltage regulator and the power-on reset when the brownout detector is deactivated. Activating the brownout detector adds 20 μA static current.

The dynamic power consumption on VDDCORE is less than 50 mA at full speed when running out of the Flash. Under the same conditions, the power consumption on VDDFLASH does not exceed 10 mA.

5.3 Voltage Regulator

8

The AT91SAM7S64 embeds a voltage regulator that is managed by the System Controller.

In Normal Mode, the voltage regulator consumes less than 100 μA static current and draws 100 mA of output current.

The voltage regulator also has a Low-power Mode. In this mode, it consumes less than 20 μ A static current and draws 1 mA of output current.

Adequate output supply decoupling is mandatory for VDDOUT to reduce ripple and avoid oscillations. The best way to achieve this is to use two capacitors in parallel: one external 470 pF (or 1 nF) NPO capacitor must be connected between VDDOUT and GND as close to the chip as possible. One external 2.2 μ F (or 3.3 μ F) X7R capacitor must be connected between VDDOUT and GND.

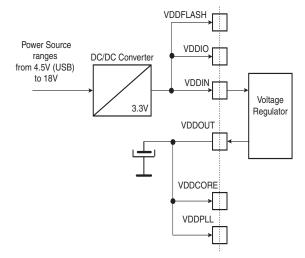
Adequate input supply decoupling is mandatory for VDDIN in order to improve startup stability and reduce source voltage drop. The input decoupling capacitor should be placed close to the chip. For example, two capacitors can be used in parallel: 100 nF NPO and 4.7 µF X7R.

5.4 Typical Powering Schematics

5.4.1 3.3V Single Supply

The AT91SAM7S64 supports a 3.3V single supply mode. The internal regulator is connected to the 3.3V source and its output feeds VDDCORE and the VDDPLL. Figure 5-1 shows the power schematics to be used for USB bus-powered systems.

Figure 5-1. 3.3V System Single Power Supply Schematic







6. I/O Lines Considerations

6.1 JTAG Port Pins

TMS, TDI and TCK are schmitt trigger inputs. TMS and TCK are 5-V tolerant, TDI is not. TMS, TDI and TCK do not integrate a pull-up resistor.

TDO is an output, driven at up to VDDIO, and has no pull-up resistor.

The pin JTAGSEL is used to select the JTAG boundary scan when asserted at a high level. The pin JTAGSEL integrates a permanent pull-down resistor of about 15 k Ω to GND, so that it can be left unconnected for normal operations.

6.2 Test Pin

The pin TST is used for manufacturing test or fast programming mode of the AT91SAM7S64 when asserted high. The pin TST integrates a permanent pull-down resistor of about 15 k Ω to GND, so that it can be left unconnected for normal operations.

To enter fast programming mode, the TST pin and the PA0 and PA1 pins should be both tied high.

Driving the TST pin at a high level while PA0 or PA1 is driven at 0 leads to unpredictable results.

6.3 Reset Pin

The pin NRST is bidirectional. It is handled by the on-chip reset controller and can be driven low to provide a reset signal to the external components or asserted low externally to reset the microcontroller. There is no constraint on the length of the reset pulse, and the reset controller can guarantee a minimum pulse length. This allows connection of a simple push-button on the pin NRST as system user reset, and the use of the signal NRST to reset all the components of the system.

The pin NRST integrates a permanent pull-up resistor to VDDIO.

6.4 ERASE Pin

The pin ERASE is used to re-initialize the Flash content and some of its NVM bits. It integrates a permanent pull-down resistor of about 15 k Ω to GND, so that it can be left unconnected for normal operations.

6.5 PIO Controller A Lines

All the I/O lines PA0 to PA31 are 5V-tolerant and all integrate a programmable pull-up resistor. Programming of this pull-up resistor is performed independently for each I/O line through the PIO controllers.

5V-tolerant means that the I/O lines can drive voltage level according to VDDIO, but can be driven with a voltage of up to 5.5V. However, driving an I/O line with a voltage over VDDIO while the programmable pull-up resistor is enabled can lead to unpredictable results. Care should be taken, in particular at reset, as all the I/O lines default to input with pull-up resistor enabled at reset.

6.6 I/O Line Drive Levels

The PIO lines PA0 to PA3 are high-drive current capable. Each of these I/O lines can drive up to 16 mA permanently.

The remaining I/O lines can draw only 8 mA.

However, the total current drawn by all the I/O lines cannot exceed 150 mA.





7. Processor and Architecture

7.1 ARM7TDMI Processor

- RISC processor based on ARMv4T Von Neumann architecture
 - Runs at up to 55 MHz, providing 0.9 MIPS/MHz
- Two instruction sets
 - ARM® high-performance 32-bit instruction set
 - Thumb® high code density 16-bit instruction set
- Three-stage pipeline architecture
 - Instruction Fetch (F)
 - Instruction Decode (D)
 - Execute (E)

7.2 Debug and Test Features

- Integrated embedded in-circuit emulator
 - Two watchpoint units
 - Test access port accessible through a JTAG protocol
 - Debug communication channel
- Debug Unit
 - Two-pin UART
 - Debug communication channel interrupt handling
 - Chip ID Register
- IEEE1149.1 JTAG Boundary-scan on all digital pins

7.3 Memory Controller

- · Bus Arbiter
 - Handles requests from the ARM7TDMI and the Peripheral DMA Controller
- · Address decoder provides selection signals for
 - Three internal 1 Mbyte memory areas
 - One 256 Mbyte embedded peripheral area
- · Abort Status Registers
 - Source, Type and all parameters of the access leading to an abort are saved
 - Facilitates debug by detection of bad pointers
- Misalignment Detector
 - Alignment checking of all data accesses
 - Abort generation in case of misalignment
- Remap Command
 - Remaps the SRAM in place of the embedded non-volatile memory
 - Allows handling of dynamic exception vectors
- Embedded Flash Controller
 - Embedded Flash interface, up to three programmable wait states

- Prefetch buffer, bufferizing and anticipating the 16-bit requests, reducing the required wait states
- Key-protected program, erase and lock/unlock sequencer
- Single command for erasing, programming and locking operations
- Interrupt generation in case of forbidden operation

7.4 Peripheral DMA Controller (PDC)

- Handles data transfer between peripherals and memories
- Eleven channels
 - Two for each USART
 - Two for the Debug Unit
 - Two for the Serial Synchronous Controller
 - Two for the Serial Peripheral Interface
 - One for the Analog-to-digital Converter
- · Low bus arbitration overhead
 - One Master Clock cycle needed for a transfer from memory to peripheral
 - Two Master Clock cycles needed for a transfer from peripheral to memory
- Next Pointer management for reducing interrupt latency requirements





8. Memory

- 64 Kbytes of Flash Memory
 - 512 pages of 128 bytes
 - Fast access time, 30 MHz single-cycle access in Worst Case conditions
 - Page programming time: 4 ms, including page auto-erase
 - Page programming without auto-erase: 2 ms
 - Full chip erase time: 10 ms
 - 10,000 write cycles, 10-year data retention capability
 - 16 lock bits, each protecting 16 sectors of 32 pages
 - Protection Mode to secure contents of the Flash
- 16 Kbytes of Fast SRAM
 - Single-cycle access at full speed

8.1 Memory Mapping

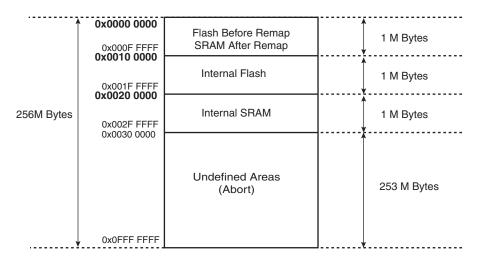
8.1.1 Internal SRAM

The AT91SAM7S64 embeds a high-speed 16-Kbyte SRAM bank. After reset and until the Remap Command is performed, the SRAM is only accessible at address 0x0020 0000. After Remap, the SRAM also becomes available at address 0x0.

8.1.2 Internal Flash

The AT91SAM7S64 features one bank of 64 Kbytes of Flash. At any time, the Flash is mapped to address 0x0010 0000. It is also accessible at address 0x0 after the reset and before the Remap Command.

Figure 8-1. Internal Memory Mapping



8.2 Embedded Flash

8.2.1 Flash Overview

The Flash of the AT91SAM7S64 is organized in 512 pages of 128 bytes. The 65,536 bytes are organized in 32-bit words.

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The Flash contains a 128-byte write buffer, accessible through a 32-bit interface.

The Flash benefits from the integration of a power reset cell and from the brownout detector. This prevents code corruption during power supply changes, even in the worst conditions.

When Flash is not used (read or write access), it is automatically placed into standby mode.

8.2.2 Embedded Flash Controller

The Embedded Flash Controller (EFC) manages accesses performed by the masters of the system. It enables reading the Flash and writing the write buffer. It also contains a User Interface, mapped within the Memory Controller on the APB. The User Interface allows:

- programming of the access parameters of the Flash (number of wait states, timings, etc.)
- starting commands such as full erase, page erase, page program, NVM bit set, NVM bit clear, etc.
- · getting the end status of the last command
- getting error status
- programming interrupts on the end of the last commands or on errors

The Embedded Flash Controller also provides a dual 32-bit Prefetch Buffer that optimizes 16-bit access to the Flash. This is particularly efficient when the processor is running in Thumb mode.

8.2.3 Lock Regions

The Embedded Flash Controller manages 16 lock bits to protect 16 regions of the flash against inadvertent flash erasing or programming commands. The AT91SAM7S64 contains 16 lock regions and each lock region contains 32 pages of 128 bytes. Each lock region has a size of 4 Kbytes.

If a locked-regions erase or program command occurs, the command is aborted and the EFC trigs an interrupt.

The 16 NVM bits are software programmable through the EFC User Interface. The command "Set Lock Bit" enables the protection. The command "Clear Lock Bit" unlocks the lock region.

Asserting the ERASE pin clears the lock bits, thus unlocking the entire Flash.

8.2.4 Security Bit Feature

The AT91SAM7S64 features a security bit, based on a specific NVM-Bit. When the security is enabled, any access to the Flash, either through the ICE interface or through the Fast Flash Programming Interface, is forbidden. This ensures the confidentiality of the code programmed in the Flash.

This security bit can only be enabled, through the Command "Set Security Bit" of the EFC User Interface. Disabling the security bit can only be achieved by asserting the ERASE pin at 1, and after a full flash erase is performed. When the security bit is deactivated, all accesses to the flash are permitted.

It is important to note that the assertion of the ERASE pin should always be longer than 50 ms.

As the ERASE pin integrates a permanent pull-down, it can be left unconnected during normal operation. However, it is safer to connect it directly to GND for the final application.





8.2.5 Non-volatile Brownout Detector Control

Two general purpose NVM (GPNVM) bits are used for controlling the brownout detector (BOD), so that even after a power loss, the brownout detector operations remain as defined by the user.

These two GPNVM bits can be cleared or set respectively through the commands "Clear General-purpose NVM Bit" and "Set General-purpose NVM Bit" of the EFC User Interface.

- GPNVM Bit 0 is used as a brownout detector enable bit. Setting the GPNVM Bit 0 enables
 the BOD, clearing it disables the BOD. Asserting ERASE clears the GPNVM Bit 0 and thus
 disables the brownout detector by default.
- The GPNVM Bit 1 is used as a brownout reset enable signal for the reset controller. Setting
 the GPNVM Bit 1 enables the brownout reset when a brownout is detected, Clearing the
 GPNVM Bit 1 disables the brownout reset. Asserting ERASE disables the brownout reset
 by default.

8.2.6 Calibration Bits

Eight NVM bits are used to calibrate the brownout detector and the voltage regulator. These bits are factory configured and cannot be changed by the user. The ERASE pin has no effect on the calibration bits.

8.3 Fast Flash Programming Interface

The Fast Flash Programming Interface allows programming the device through either a serial JTAG interface or through a multiplexed fully-handshaked parallel port. It allows gang-programming with market-standard industrial programmers.

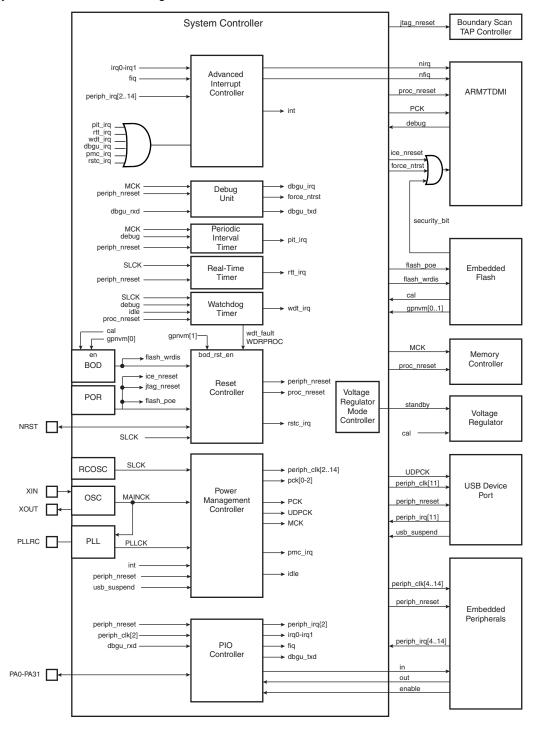
The FFPI supports read, page program, page erase, full erase, lock, unlock and protect commands.

The Fast Flash Programming Interface is enabled and the Fast Programming Mode is entered when the TST pin and the PA0 and PA1 pins are all tied high.

9. System Controller

The System Controller manages all vital blocks of the microcontroller: interrupts, clocks, power, time, debug and reset.

Figure 9-1. System Controller Block Diagram



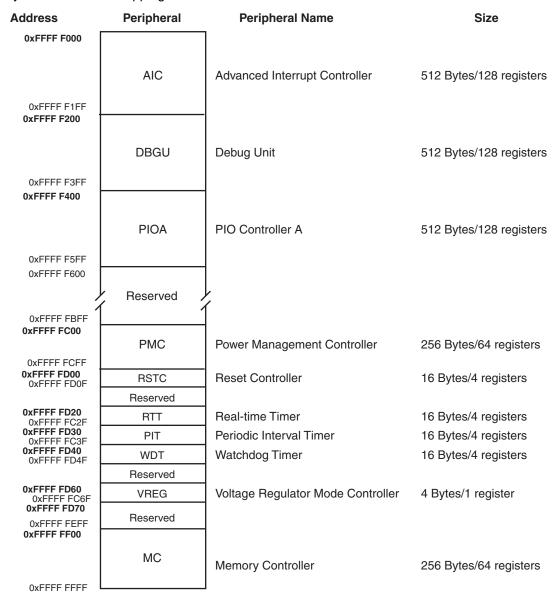


9.1 System Controller Mapping

The System Controller peripherals are all mapped to the highest 4 Kbytes of address space, between addresses 0xFFFF F000 and 0xFFFF FFFF.

Figure 9-2 shows the mapping of the System Controller. Note that the Memory Controller configuration user interface is also mapped within this address space.

Figure 9-2. System Controller Mapping



9.2 Reset Controller

The Reset Controller is based on a power-on reset cell and one brownout detector. It gives the status of the last reset, indicating whether it is a power-up reset, a software reset, a user reset, a watchdog reset or a brownout reset. In addition, it controls the internal resets and the NRST pin output. It allows to shape a signal on the NRST line, guaranteeing that the length of the pulse meets any requirement.

Note that if NRST is used as a reset output signal for external devices during power-off, the brownout detector must be activated.

9.2.1 Brownout Detector and Power-on Reset

The AT91SAM7S64 embeds a brownout detection circuit and a power-on reset cell. Both are supplied with and monitor VDDCORE. Both signals are provided to the Flash to prevent any code corruption during power-up or power-down sequences or if brownouts occur on the VDDCORE power supply.

The power-on reset cell has a limited-accuracy threshold at around 1.5V. Its output remains low during power-up until VDDCORE goes over this voltage level. This signal goes to the reset controller and allows a full re-initialization of the device.

The brownout detector monitors the VDDCORE level during operation by comparing it to a fixed trigger level. It secures system operations in the most difficult environments and prevents code corruption in case of brownout on the VDDCORE.

Only VDDCORE is monitored, as a voltage drop on VDDFLASH or any other power supply of the device cannot affect the Flash.

When the brownout detector is enabled and VDDCORE decreases to a value below the trigger level (Vbot-, defined as Vbot - hyst/2), the brownout output is immediately activated.

When VDDCORE increases above the trigger level (Vbot+, defined as Vbot + hyst/2), the reset is released. The brownout detector only detects a drop if the voltage on VDDCORE stays below the threshold voltage for longer than about 1µs.

The threshold voltage has a hysteresis of about 50 mV, to ensure spike free brownout detection. The typical value of the brownout detector threshold is 1.68V with an accuracy of \pm 2% and is factory calibrated.

The brownout detector is low-power, as it consumes less than 20 μ A static current. However, it can be deactivated to save its static current. In this case, it consumes less than 1 μ A. The deactivation is configured through the GPNVM bit 0 of the Flash.

9.3 Clock Generator

The Clock Generator embeds one low-power RC Oscillator, one Main Oscillator and one PLL with the following characteristics:

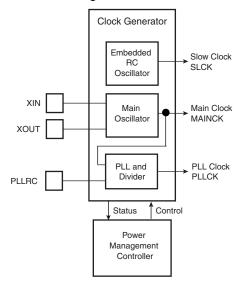
- RC Oscillator range is between 22 KHz and 42 KHz
- Main Oscillator frequency ranges between 3 and 20 MHz
- Main Oscillator can be bypassed
- PLL output ranges between 80 and 220 MHz

It provides SLCK, MAINCK and PLLCK.





Figure 9-3. Clock Generator Block Diagram



9.4 Power Management Controller

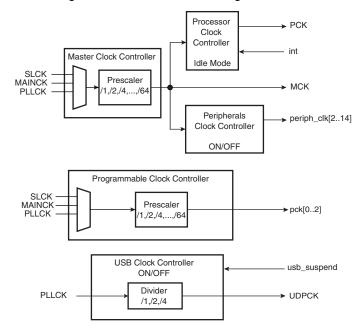
The Power Management Controller uses the Clock Generator outputs to provide:

- the Processor Clock PCK
- the Master Clock MCK
- the USB Clock UDPCK
- all the peripheral clocks, independently controllable
- three programmable clock outputs

The Master Clock (MCK) is programmable from a few hundred Hz to the maximum operating frequency of the device.

The Processor Clock (PCK) switches off when entering processor idle mode, thus allowing reduced power consumption while waiting for an interrupt.

Figure 9-4. Power Management Controller Block Diagram



9.5 Advanced Interrupt Controller

- Controls the interrupt lines (nIRQ and nFIQ) of an ARM Processor
- Individually maskable and vectored interrupt sources
 - Source 0 is reserved for the Fast Interrupt Input (FIQ)
 - Source 1 is reserved for system peripherals (RTT, PIT, EFC, PMC, DBGU, etc.)
 - Other sources control the peripheral interrupts or external interrupts
 - Programmable edge-triggered or level-sensitive internal sources
 - Programmable positive/negative edge-triggered or high/low level-sensitive external sources
- 8-level Priority Controller
 - Drives the normal interrupt of the processor
 - Handles priority of the interrupt sources
 - Higher priority interrupts can be served during service of lower priority interrupt
- Vectoring
 - Optimizes interrupt service routine branch and execution
 - One 32-bit vector register per interrupt source
 - Interrupt vector register reads the corresponding current interrupt vector
- Protect Mode
 - Easy debugging by preventing automatic operations
- Fast Forcing
 - Permits redirecting any interrupt source on the fast interrupt
- General Interrupt Mask
 - Provides processor synchronization on events without triggering an interrupt





9.6 Debug Unit

- Comprises:
 - One two-pin UART
 - One Interface for the Debug Communication Channel (DCC) support
 - One set of Chip ID Registers
 - One interface providing ICE Access Prevention
- Two-pin UART
 - Implemented features are compatible with the USART
 - Programmable Baud Rate Generator
 - Parity, Framing and Overrun Error
 - Automatic Echo, Local Loopback and Remote Loopback Channel Modes
- Debug Communication Channel Support
 - Offers visibility of COMMRX and COMMTX signals from the ARM Processor
- Chip ID Registers
 - Identification of the device revision, sizes of the embedded memories, set of peripherals
 - Chip ID is 0x27090540 (VERSION 0)

9.7 Periodic Interval Timer

• 20-bit programmable counter plus 12-bit interval counter

9.8 Watchdog Timer

- 12-bit key-protected Programmable Counter running on prescaled SLCK
- Provides reset or interrupt signals to the system
- Counter may be stopped while the processor is in debug state or in idle mode

9.9 Real-time Timer

- 32-bit free-running counter with alarm running on prescaled SLCK
- Programmable 16-bit prescaler for SLCK accuracy compensation

9.10 PIO Controller

- One PIO Controller, controlling 32 I/O lines
- Fully programmable through set/clear registers
- Multiplexing of two peripheral functions per I/O line
- For each I/O line (whether assigned to a peripheral or used as general-purpose I/O)
 - Input change interrupt
 - Half a clock period glitch filter
 - Multi-drive option enables driving in open drain
 - Programmable pull-up on each I/O line
 - Pin data status register, supplies visibility of the level on the pin at any time
- Synchronous output, provides Set and Clear of several I/O lines in a single write

9.11 Voltage Regulator Controller

The aim of this controller is to select the Power Mode of the Voltage Regulator between Normal Mode (bit 0 is cleared) or Standby Mode (bit 0 is set).



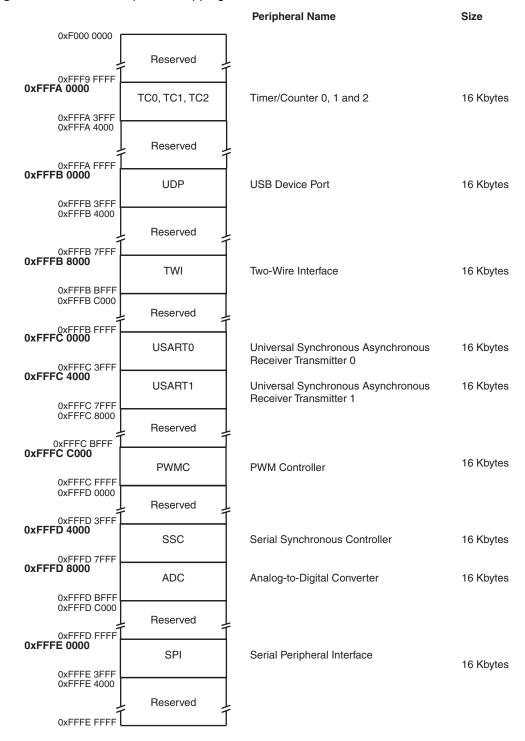


10. Peripherals

10.1 Peripheral Mapping

Each peripheral is allocated 16 Kbytes of address space.

Figure 10-1. User Peripheral Mapping



10.2 Peripheral Multiplexing on PIO Lines

The AT91SAM7S64 features one PIO controller, PIOA, that multiplexes the I/O lines of the peripheral set.

PIO Controller A controls 32 lines. Each line can be assigned to one of two peripheral functions, A or B. Some of them can also be multiplexed with the analog inputs of the ADC Controller.

Table 10-1 on page 26 defines how the I/O lines of the peripherals A, B or the analog inputs are multiplexed on the PIO Controller A. The two columns "Function" and "Comments" have been inserted for the user's own comments; they may be used to track how pins are defined in an application.

Note that some peripheral functions that are output only may be duplicated in the table.

All pins reset in their Parallel I/O lines function are configured in input with the programmable pull-up enabled, so that the device is maintained in a static state as soon as a reset is detected.





10.3 PIO Controller A Multiplexing

Table 10-1. Multiplexing on PIO Controller A

PIO Controller A			Application U	Application Usage		
I/O Line	Peripheral A	Peripheral B	Comments	Function	Comments	
PA0	PWM0	TIOA0	High-Drive			
PA1	PWM1	TIOB0	High-Drive			
PA2	PWM2	SCK0	High-Drive			
PA3	TWD	NPCS3	High-Drive			
PA4	TWCK	TCLK0				
PA5	RXD0	NPCS3				
PA6	TXD0	PCK0				
PA7	RTS0	PWM3				
PA8	CTS0	ADTRG				
PA9	DRXD	NPCS1				
PA10	DTXD	NPCS2				
PA11	NPCS0	PWM0				
PA12	MISO	PWM1				
PA13	MOSI	PWM2				
PA14	SPCK	PWM3				
PA15	TF	TIOA1				
PA16	TK	TIOB1				
PA17	TD	PCK1	AD0			
PA18	RD	PCK2	AD1			
PA19	RK	FIQ	AD2			
PA20	RF	IRQ0	AD3			
PA21	RXD1	PCK1				
PA22	TXD1	NPCS3				
PA23	SCK1	PWM0				
PA24	RTS1	PWM1				
PA25	CTS1	PWM2				
PA26	DCD1	TIOA2				
PA27	DTR1	TIOB2				
PA28	DSR1	TCLK1				
PA29	RI1	TCLK2				
PA30	IRQ1	NPCS2				
PA31	NPCS1	PCK2				

10.4 Peripheral Identifiers

The AT91SAM7S64 embeds a wide range of peripherals. Table 10-2 defines the Peripheral Identifiers of the AT91SAM7S64. A peripheral identifier is required for the control of the peripheral interrupt with the Advanced Interrupt Controller and for the control of the peripheral clock with the Power Management Controller.

Table 10-2. Peripheral Identifiers

Peripheral	Peripheral	Peripheral	External
ID	Mnemonic	Name	Interrupt
0	AIC	Advanced Interrupt Controller	FIQ
1	SYSIRQ ⁽¹⁾	System Interrupt	
2	PIOA	Parallel I/O Controller A	
3	Reserved		
4	ADC ⁽¹⁾	Analog-to Digital Converter	
5	SPI	Serial Peripheral Interface	
6	US0	USART 0	
7	US1	USART 1	
8	SSC	Synchronous Serial Controller	
9	TWI	Two-wire Interface	
10	PWMC	PWM Controller	
11	UDP	USB Device Port	
12	TC0	Timer/Counter 0	
13	TC1	Timer/Counter 1	
14	TC2	Timer/Counter 2	
15 - 29	Reserved		
30	AIC	Advanced Interrupt Controller	IRQ0
31	AIC	Advanced Interrupt Controller	IRQ1

Note:

 Setting SYSIRQ and ADC bits in the clock set/clear registers of the PMC has no effect. The System Controller is continuously clocked. The ADC clock is automatically started for the first conversion. In Sleep Mode the ADC clock is automatically stopped after each conversion.

10.5 Serial Peripheral Interface

- Supports communication with external serial devices
 - Four chip selects with external decoder allow communication with up to 15 peripherals
 - Serial memories, such as DataFlash® and 3-wire EEPROMs
 - Serial peripherals, such as ADCs, DACs, LCD Controllers, CAN Controllers and Sensors
 - External co-processors
- · Master or slave serial peripheral bus interface
 - 8- to 16-bit programmable data length per chip select
 - Programmable phase and polarity per chip select





- Programmable transfer delays between consecutive transfers and between clock and data per chip select
- Programmable delay between consecutive transfers
- Selectable mode fault detection
- Maximum frequency at up to Master Clock

10.6 Two-wire Interface

- Master Mode only
- Compatibility with standard two-wire serial memories
- One, two or three bytes for slave address
- Sequential read/write operations

10.7 USART

- Programmable Baud Rate Generator
- 5- to 9-bit full-duplex synchronous or asynchronous serial communications
 - 1, 1.5 or 2 stop bits in Asynchronous Mode
 - 1 or 2 stop bits in Synchronous Mode
 - Parity generation and error detection
 - Framing error detection, overrun error detection
 - MSB or LSB first
 - Optional break generation and detection
 - By 8 or by 16 over-sampling receiver frequency
 - Hardware handshaking RTS CTS
 - Modem Signals Management DTR-DSR-DCD-RI on USART1
 - Receiver time-out and transmitter timeguard
 - Multi-drop Mode with address generation and detection
- RS485 with driver control signal
- ISO7816, T = 0 or T = 1 Protocols for interfacing with smart cards
 - NACK handling, error counter with repetition and iteration limit
- IrDA modulation and demodulation
 - Communication at up to 115.2 Kbps
- Test Modes
 - Remote Loopback, Local Loopback, Automatic Echo

10.8 Serial Synchronous Controller

- Provides serial synchronous communication links used in audio and telecom applications
- Contains an independent receiver and transmitter and a common clock divider
- Offers a configurable frame sync and data length
- Receiver and transmitter can be programmed to start automatically or on detection of different event on the frame sync signal
- Receiver and transmitter include a data signal, a clock signal and a frame synchronization signal

10.9 Timer Counter

- Three 16-bit Timer Counter Channels
 - Three output compare or two input capture
- · Wide range of functions including:
 - Frequency measurement
 - Event counting
 - Interval measurement
 - Pulse generation
 - Delay timing
 - Pulse Width Modulation
 - Up/down capabilities
- Each channel is user-configurable and contains:
 - Three external clock inputs
 - Five internal clock inputs, as defined in Table 10-3

Table 10-3. Timer Counter Clocks Assignment

TC Clock Input	Clock
TIMER_CLOCK1	MCK/2
TIMER_CLOCK2	MCK/8
TIMER_CLOCK3	MCK/32
TIMER_CLOCK4	MCK/128
TIMER_CLOCK5	MCK/1024

- Two multi-purpose input/output signals
- Two global registers that act on all three TC channels

10.10 PWM Controller

- Four channels, one 16-bit counter per channel
- · Common clock generator, providing thirteen different clocks
 - One Modulo n counter providing eleven clocks
 - Two independent linear dividers working on modulo n counter outputs
- Independent channel programming
 - Independent enable/disable commands
 - Independent clock selection
 - Independent period and duty cycle, with double bufferization
 - Programmable selection of the output waveform polarity
 - Programmable center or left aligned output waveform

10.11 USB Device Port

- USB V2.0 full-speed compliant, 12 Mbits per second.
- Embedded USB V2.0 full-speed transceiver





- Embedded 328-byte dual-port RAM for endpoints
- · Four endpoints
 - Endpoint 0: 8 bytes
 - Endpoint 1 and 2: 64 bytes ping-pong
 - Endpoint 3: 64 bytes
 - Ping-pong Mode (two memory banks) for bulk endpoints
- Suspend/resume logic

10.12 Analog-to-digital Converter

- 8-channel ADC
- 10-bit 100 Ksamples/sec. Successive Approximation Register ADC
- -2/+2 LSB Integral Non Linearity, -1/+2 LSB Differential Non Linearity
- Integrated 8-to-1 multiplexer, offering eight independent 3.3V analog inputs
- Individual enable and disable of each channel
- External voltage reference for better accuracy on low voltage inputs
- Multiple trigger source
 - Hardware or software trigger
 - External trigger pin
 - Timer Counter 0 to 2 outputs TIOA0 to TIOA2 trigger
- Sleep Mode and conversion sequencer
 - Automatic wakeup on trigger and back to sleep mode after conversions of all enabled channels

Four of eight analog inputs shared with digital signals

11. Ordering Information

 Table 11-1.
 Ordering Information

Ordering Code	Package	Package Type	ROM Code Revision	Temperature Operating Range
AT91SAM7S64-AU-001	LQFP 64	Green	001	Industrial (-40°C to 85°C)





12. Revision History

13.

Doc. Rev	Source	Comments	
6070AS		• Date: 19-Nov-04	
6070BS		• Date: 07-Jan-04	
	• CSR 04-427	pg. 19, PLL Output range changed	
	• CSR 05-010	• pg. 30, Table 6: Ordering Information. Table replaced.	



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